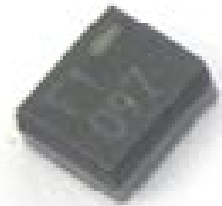


1. Features

- Low EMI noise and small footprint (5mm²) using inductor-embedded ferrite substrate
- High efficiency using synchronous rectifier technology at 3MHz operation
- PFM/PWM automatic mode switching function
- Smooth mode transient between PFM mode and PWM mode with low-ripple-voltage PFM mode
- 2% DC voltage accuracy over full load current range
- Wide input voltage range : 2.3~5.5V
- Maximum Load Current: 600mA (depends on output voltage)
- Fixed output voltage: 0.8V – 4V (factory setting, 50mV step)
- Internal soft start, overcurrent protection



2. Description

The LXDC2HN series is a low power step-down DC-DC converter, which is suitable for a space-limited or a noise-sensitive application. The device utilizes an inductor-embedded ferrite substrate, and the substrate eliminates radiated EMI noise and conduction noise efficiently.

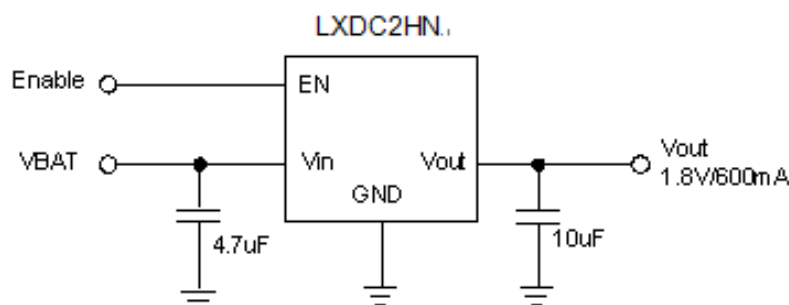
By just putting input/output capacitors, it can be used as a LDO replacement. Its low noise feature and easy to assembly feature assures reliable power supply quality.

The device works in PFM mode at light load and it extends the battery life. At heavy load, its control mode changes to PMW mode automatically and it keeps high efficiency using synchronous rectifying technology.

The device keeps good output voltage accuracy even in PFM mode. It keeps 2% DC voltage accuracy over full current range (0-600mA), and shows very smooth mode transient between PFM mode and PWM mode.

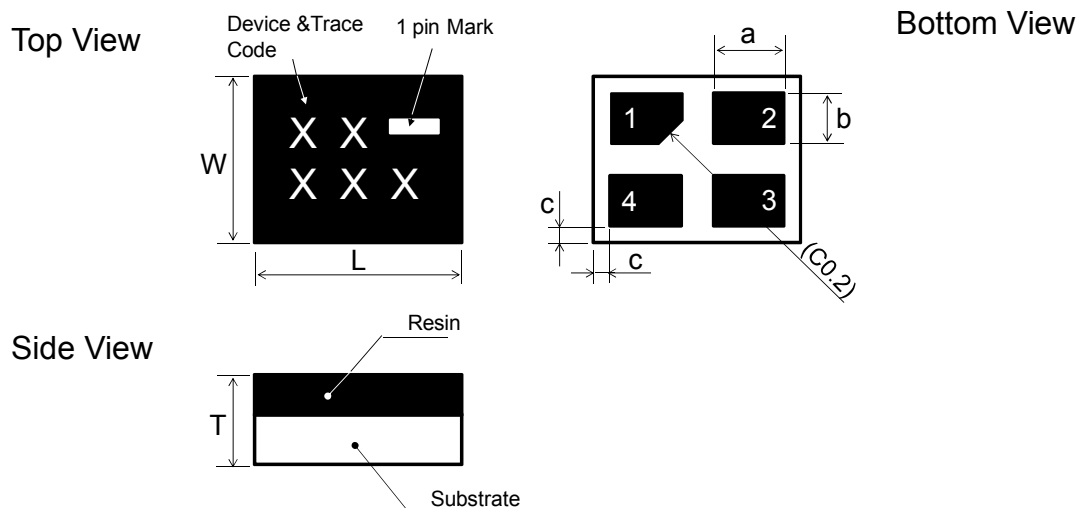
LXDC2HN series has resin top coat to make it easy to be picked up in factory assembly.

3. Typical Application Circuit



4. Mechanical details

4-1 Outline



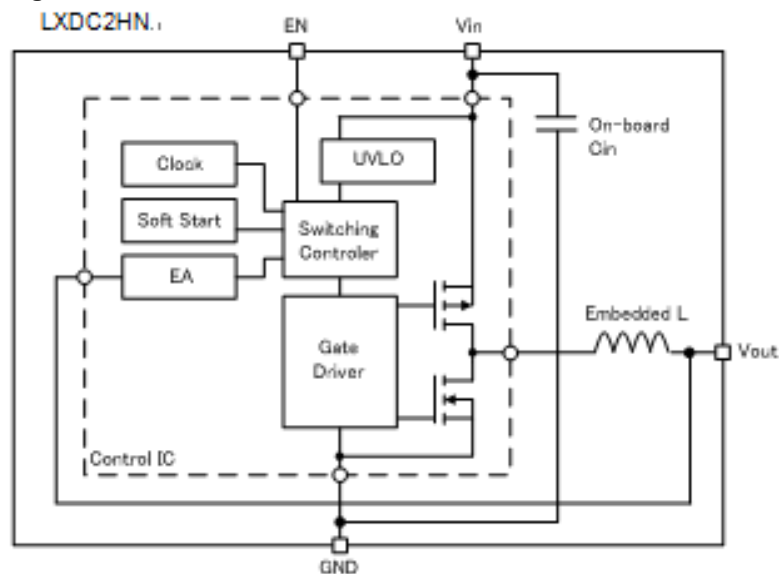
Unit: mm

Mark	Dimension
L	2.5 +/- 0.2
W	2.0 +/- 0.2
T	1.2 MAX
a	0.85 +/- 0.1
b	0.60 +/- 0.1
c	0.15 +/- 0.15

4-2. Pin Function

Pin	Symbol	I/O	Description
1	Vin	Input	Vin pin supplies current to the LXDC2HN internal regulator.
2	EN	Input	This is the ON/OFF control pin of the device. Connecting this pin to GND keeps the device in shutdown mode. Pulling this pin to Vin enables the device with soft start. This pin must not be left floating and must be terminated. If this pin is left open, the device may be off around 100mA output. EN=H: Device ON, EN=L: Device OFF
3	Vout	Output	Regulated voltage output pin. Apply output load between this pin and GND.
4	GND	-	Ground pin

4-3. Functional Block Diagram



5. Ordering Information

Part number	Output Voltage	Device Specific Feature	MOQ
LXDC2HN10A-132	1.0V	Standard type	T/R, 3000pcs/R
LXDC2HN11A-214	1.1V	Standard type	T/R, 3000pcs/R
LXDC2HN12A-099	1.2V	Standard type	T/R, 3000pcs/R
LXDC2HN1CA-261	1.25V	Standard type	T/R, 3000pcs/R
LXDC2HN13A-236	1.3V	Standard type	T/R, 3000pcs/R
LXDC2HN1DA-133	1.35V	Standard type	T/R, 3000pcs/R
LXDC2HN15A-126	1.5V	Standard type	T/R, 3000pcs/R
LXDC2HN18A-097	1.8V	Standard type	T/R, 3000pcs/R
LXDC2HN23A-324	2.3V	Standard type	T/R, 3000pcs/R
LXDC2HN25A-134	2.5V	Standard type	T/R, 3000pcs/R
LXDC2HN28A-235	2.8V	Standard type	T/R, 3000pcs/R
LXDC2HN30A-135	3.0V	Standard type	T/R, 3000pcs/R
LXDC2HN33A-136	3.3V	Standard type	T/R, 3000pcs/R

Output voltage can be set 50mV step from 0.8V to 4.0V. Please ask Murata representative.

6. Electrical Specification

6-1 Absolute maximum ratings

Parameter	symbol	rating	Unit
Input voltage	Vin, EN	6.3	V
Operating ambient temperature	Ta	-40 to +85	°C
Operating case temperature	Tc	-40 to +125	°C
Storage temperature	TSTO	-40 to +85	°C

6-2 Electrical characteristics (Ta=25°C)

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
Input voltage	V_{in}			2.3	3.6	5.5	V
UVLO voltage	UVLO			1.0	1.4	1.8	V
Input leak current	lin-off	$V_{in}=3.6V$, $EN=0V$	LXDC2HN10A-132		0	2	μA
			LXDC2HN11A-214				
			LXDC2HN12A-099				
			LXDC2HN1CA-261				
			LXDC2HN13A-236				
			LXDC2HN1DA-133				
			LXDC2HN15A-126				
			LXDC2HN18A-097				
			LXDC2HN23A-324				
			LXDC2HN25A-134				
		$V_{in}=5.0V$, $EN=0V$	LXDC2HN28A-235				
			LXDC2HN30A-135				
			LXDC2HN33A-136				
Output voltage accuracy	Vout	$V_{in}-V_{out}>1V$	LXDC2HN10A-132	0.976	1.0	1.024	V
			LXDC2HN11A-214	1.076	1.1	1.124	
			LXDC2HN12A-099	1.176	1.20	1.224	
			LXDC2HN1CA-261	1.225	1.25	1.275	
			LXDC2HN13A-236	1.27	1.30	1.33	
			LXDC2HN1DA-133	1.323	1.35	1.377	
			LXDC2HN15A-126	1.47	1.50	1.53	
			LXDC2HN18A-097	1.764	1.80	1.836	
			LXDC2HN23A-324	2.254	2.30	2.346	
			LXDC2HN25A-134	2.45	2.50	2.55	
		$V_{in}-V_{out}>0.7V$	LXDC2HN28A-235	2.744	2.80	2.856	
			LXDC2HN30A-135	2.94	3.00	3.06	
		$V_{in}-V_{out}>0.5V$	LXDC2HN33A-136	3.234	3.30	3.366	

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
Load current range	Iout	LXDC2HN10A-132		0		600	mA
		LXDC2HN11A-214					
		LXDC2HN12A-099					
		LXDC2HN1CA-261					
		LXDC2HN13A-236					
		LXDC2HN1DA-133					
		LXDC2HN15A-126					
		LXDC2HN18A-097					
		LXDC2HN23A-324		0		500	
		LXDC2HN25A-134					
		LXDC2HN28A-235		0		450	
		LXDC2HN30A-135		0		400	
		LXDC2HN33A-136		0		300	
Ripple voltage	Vrpl	Vin=3.6V, Iout=300mA, BW=100MHz	LXDC2HN10A-132		15	30	mV
			LXDC2HN11A-214				
			LXDC2HN12A-099				
			LXDC2HN1CA-261				
			LXDC2HN13A-236				
			LXDC2HN1DA-133				
			LXDC2HN15A-126				
			LXDC2HN18A-097				
			LXDC2HN23A-324				
			LXDC2HN25A-134				
		Vin=5V, Iout=300mA, BW=100MHz	LXDC2HN28A-235				
			LXDC2HN30A-135				
			LXDC2HN33A-136				

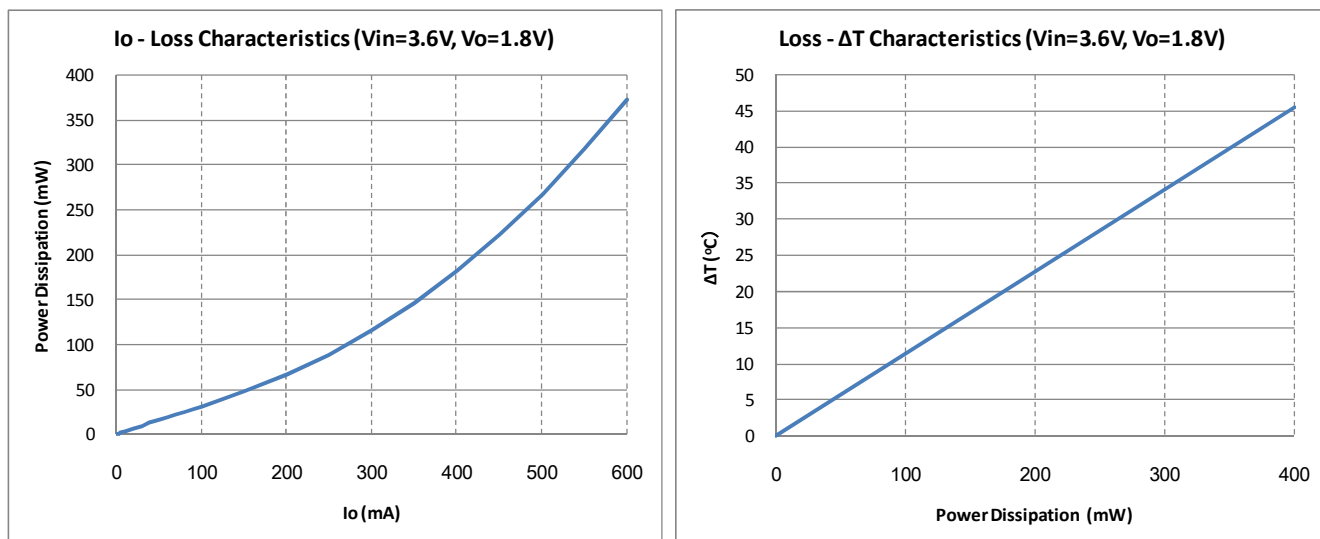
Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
Efficiency	EFF	Vin=3.6V, Iout=150mA	LXDC2HN10A-132	73	78		%
			LXDC2HN11A-214	75	79		
			LXDC2HN12A-099	75	80		
			LXDC2HN1CA-261	76	81		
			LXDC2HN13A-236	76	81		
			LXDC2HN1DA-133	77	82		
			LXDC2HN15A-126	78	83		
			LXDC2HN18A-097	81	85		
			LXDC2HN23A-324	83	87		
			LXDC2HN25A-134	84	88		
		Vin=5V, Iout=150mA	LXDC2HN28A-235	82	86		
			LXDC2HN30A-135	83	87		
			LXDC2HN33A-136	84	88		
EN control voltage	VENH	ON ; Enable		1.4		Vin	V
	VENL	OFF ; Disable		0		0.25	V
SW Frequency	Fosc			2.5	3.0	3.5	MHz
Over current protection	OCP	LXDC2HN10A-132		600	900	1200	mA
		LXDC2HN11A-214					
		LXDC2HN12A-099					
		LXDC2HN1CA-261					
		LXDC2HN13A-236					
		LXDC2HN1DA-133					
		LXDC2HN15A-126					
		LXDC2HN18A-097					
		LXDC2HN23A-324		500	900	1200	
		LXDC2HN25A-134		500	900	1200	
		LXDC2HN28A-235		500	900	1200	
		LXDC2HN30A-135		400	700	1200	
		LXDC2HN33A-136		300	700	1200	
		If the over current event continues less than Tlatch, auto-recovery. If the over current event continues more than Tlatch, latch-up. Restart by toggling EN voltage or Vin voltage					
	Tlatch	Latch-up mask time @Vout=0.8×Vnom			20		usec
	Start-up time	Ton				0.9	

(*1) External capacitors (Cin:4.7uF,Cout:10uF) shall be placed near the module in order to proper operation.

(*2)The above characteristics are tested using the application circuit on section 8.

6-3 Thermal and Current De-rating Information

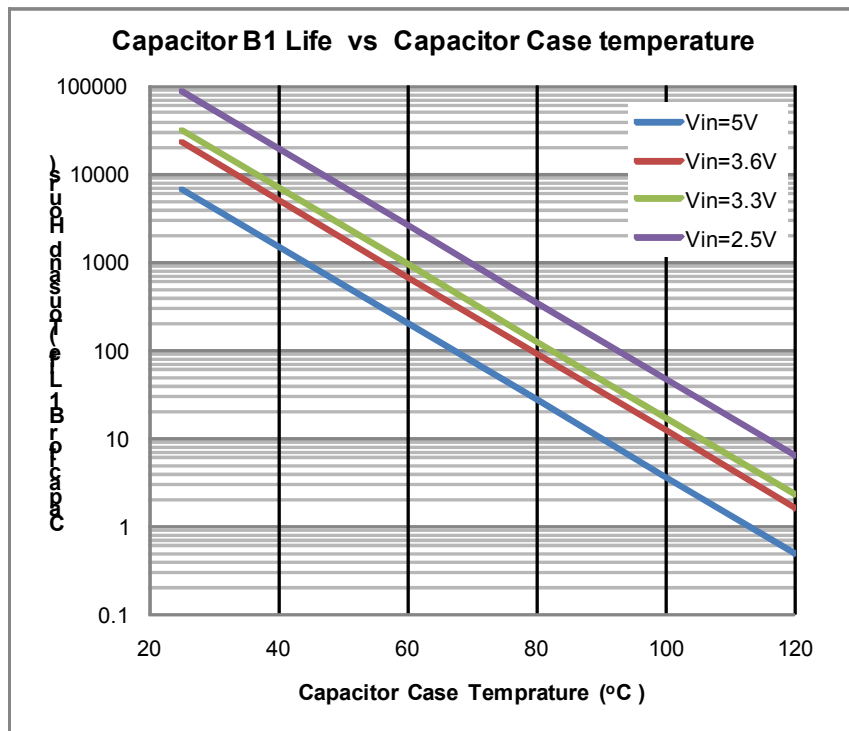
The following figure shows the power dissipation and temperature rise characteristics example. These data are measured on Murata's evaluation board of this device at no air-flow condition.



The output current of the device may need to be de-rated if it is operated in a high ambient temperature or in a continuous power delivering application. The amount of current de-rating is highly dependent on the environmental thermal conditions, i.e. PCB design, nearby components or effective air flows. Care should especially be taken in applications where the device temperature exceeds 85°C.

The case temperature of the device must be kept lower than the maximum rating of 125 °C. It is generally recommended to take an appropriate de-rating to IC temperature for a reliable operation. A general de-rating for the temperature of semiconductor is 80%.

MLCC capacitor's reliability and the lifetime is also dependant on temperature and applied voltage stress. Higher temperature and/or higher voltage cause shorter lifetime of MLCC, and the degradation can be described by the Arrhenius model. The most critical parameter of the degradation is IR (Insulation Resistance). The below figure shows MLCC's B1 life based on a failure rate reaching 1%. It should be noted that wear-out mechanisms in MLCC capacitor is not reversible but cumulative over time.



The following steps should be taken before the design fix of user's set for a reliable operation.

1. The ambient temperature of the device should be kept below 85 °C
2. The case temperature should be measured on the worst condition of each application. The temperature must be kept below 125 °C. An appropriate de-rating of temperature and/or output current should be taken.
3. The MLCC temperature should be considered as same as the case temperature. Considering the above figure, it should be checked if the expected B1 life of MLCC is acceptable or not.

7. Detailed Description

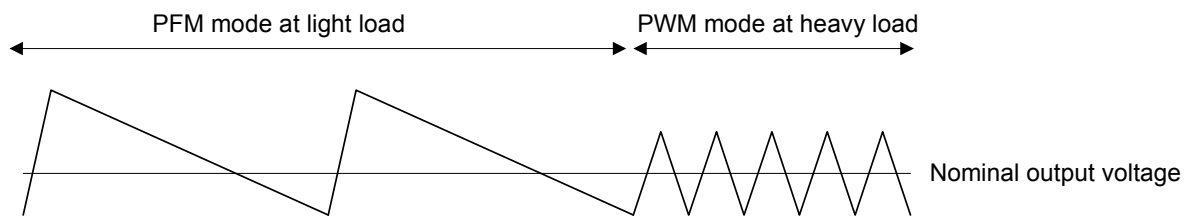
PFM/PWM Mode

If the load current decreases, the converter will enter PFM mode automatically. In PFM mode, the device operates in discontinuous current mode with a sporadic one switching pulse to keep high efficiency at light load.

The device uses constant on time control in PFM operation, which produces a low ripple voltage and accurate output voltage compared with other PFM architectures. Because of the architecture, DC output voltage can be kept within $\pm 2\%$ range of the nominal voltage and the output ripple voltage in PFM mode can be reduced by just increasing output capacitor.

The transition between PFM and PWM is also seamless and smooth.

The transition current between PFM and PWM is depend on V_{in} , V_{out} and other factors, but the ballpark threshold is about 100-200mA



UVLO (Under Voltage Lock Out)

The input voltage (V_{in}) must reach or exceed the UVLO voltage (1.4Vtyp) before the device begins the start up sequence even when EN pin kept high. UVLO function keeps away of an unstable operation at low V_{in} range

Soft Start

The device has an internal soft-start function that limits the inrush current during start-up. The soft-start system progressively increases the switching on-time from a minimum pulse-width to that of normal operation. Because of the function, the output voltage increases gradually from zero to nominal voltage at start-up event. The nominal soft-start time is 0.9msec. If you prefer a faster soft-start time, please contact Murata representative.

Enable

The device starts operation when EN is set high and starts up with soft start. For proper operation, the EN pin must be terminated to logic high and must not be left floating. If the pin is left open, the device may operate at light load but will not work at heavy load.

Pulling the EN pin to logic low forces the device shutdown. The device does not have a discharge function when it turns off. If you prefer a discharge function, please contact Murata representative.

100% Duty Cycle Operation

The device can operate 100% duty cycle mode, in which high-side switch is constantly turned ON, thereby providing a low input-to-output voltage difference.

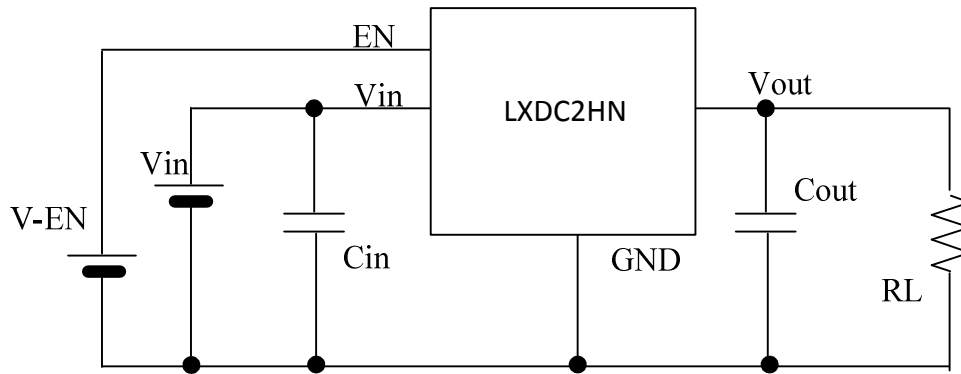
When V_{in} and V_{out} becomes close and the duty gets close to 100%, the switching pulse will skip the nominal switching period and the output voltage ripple may be larger than other condition. It should be noted that this condition does not mean a failure of the device.

Over Current Protection

When the output current reaches the OCP threshold, the device narrows the switching duty and decrease the output voltage. If the OCP event is removed within the mask time (20usec typ), the output voltage recovers to the nominal value automatically. If the OCP event continues over the mask time, the device will shutdown.

After it is shut down, it can be restarted by toggling the V_{in} or EN voltage.

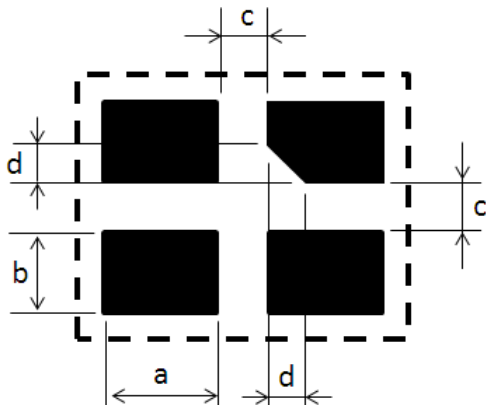
8. Test Circuit



Cin : 4.7uF/6.3V (GRM188B30J475K)

Cout : 10uF/6.3V (GRM188B30J106M)

9. Reference Land Pattern



Unit: mm

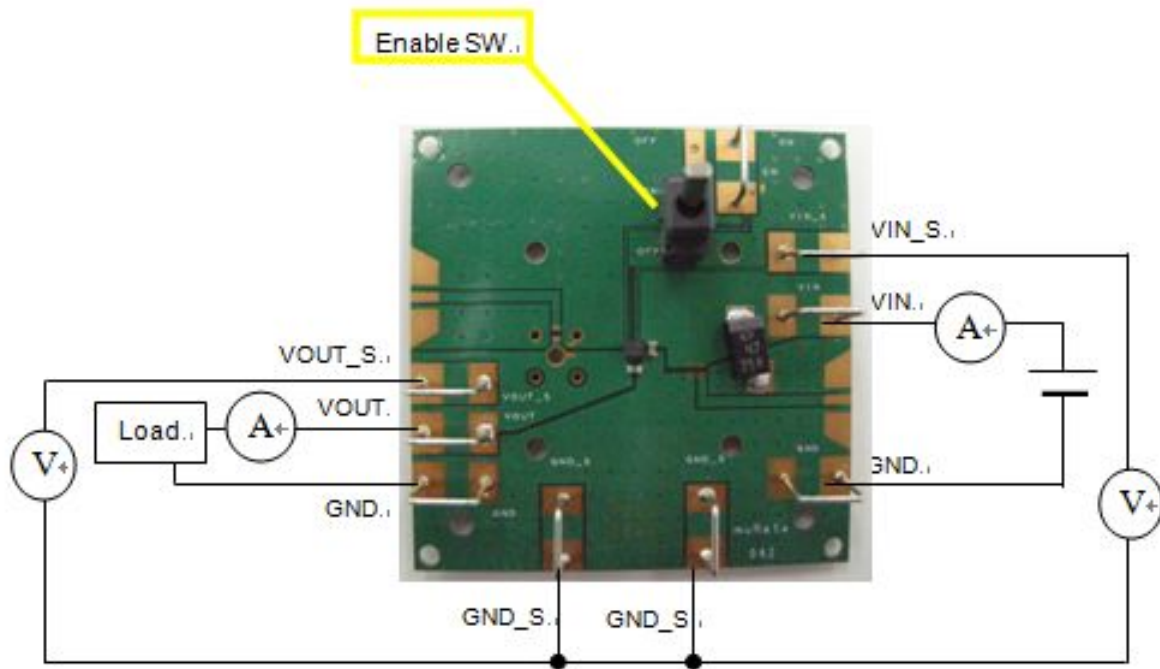
Mark	Dimension
a	0.85
b	0.60
c	0.5
d	0.2

Notes: this land layout is for reference purpose only.

10. Measurement Data

Micro DC-DC Converter evaluation board (P2LX0244)

Measurement setup



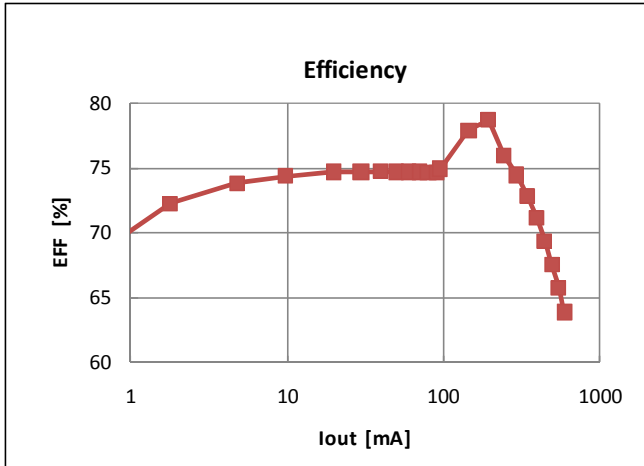
The enable switch has three positions.

1. When it is toggled to "ON" side, the device starts operation.
2. When it is toggled to "OFF" side, the device stop operation and keep shut down status.
3. When it is set to middle of "ON" and "OFF", the EN pin becomes floated and can be applied an external voltage through the EN terminal pin on the EVB. If you don't apply external voltage to EN pin, the enable switch should not to be set to the middle position.

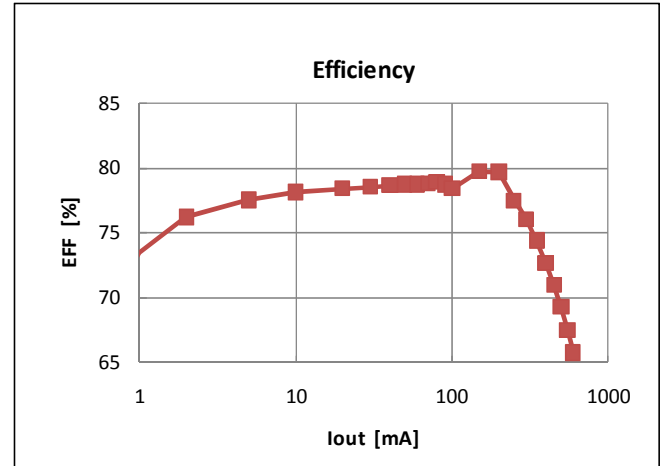
Typical Measurement Data (reference purpose only) (Ta=25°C)

Efficiency

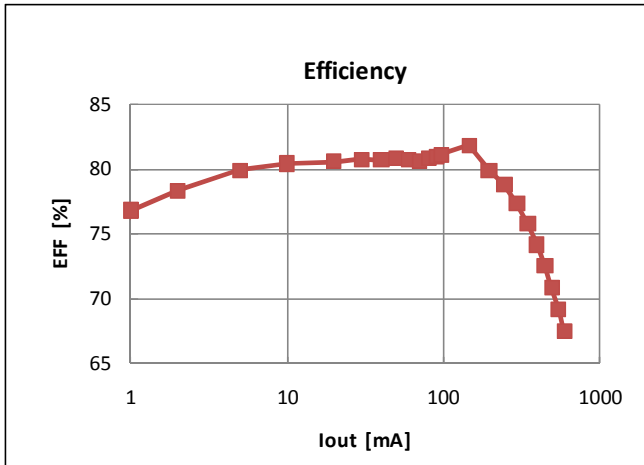
• Vin=3.6V, Vout=1.0V



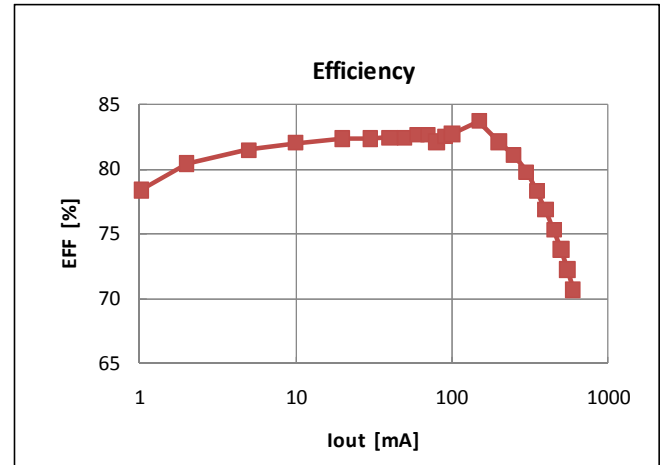
• Vin=3.6V, Vout=1.2V



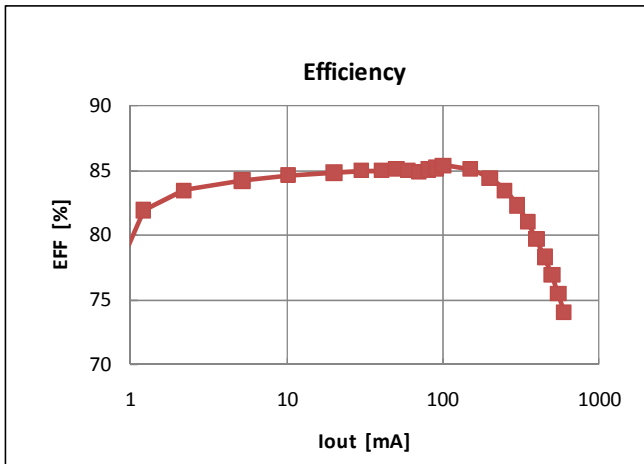
• Vin=3.6V, Vout=1.35V



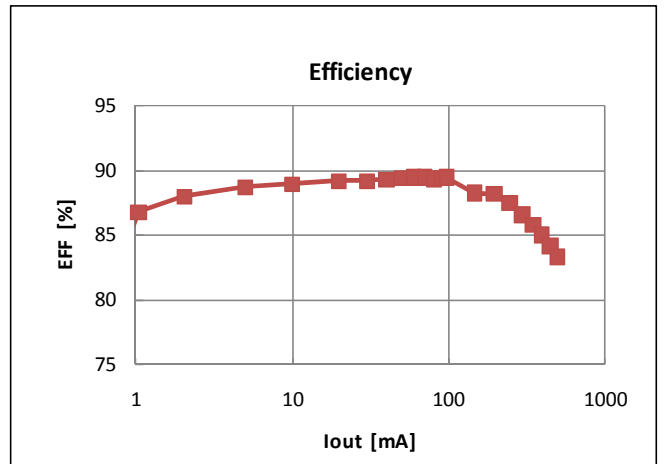
• Vin=3.6V, Vout=1.5V



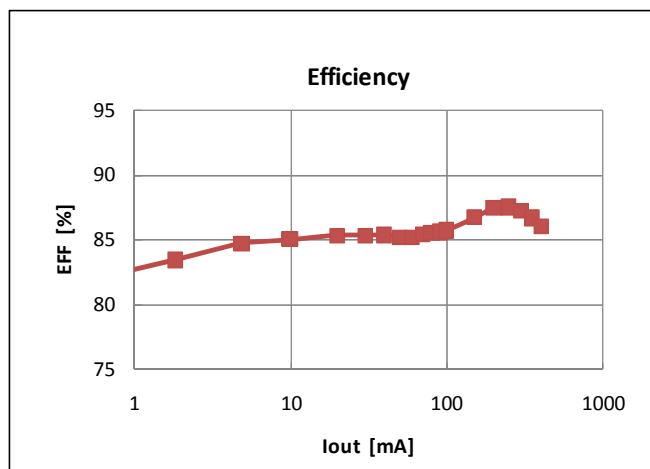
• Vin=3.6V, Vout=1.8V



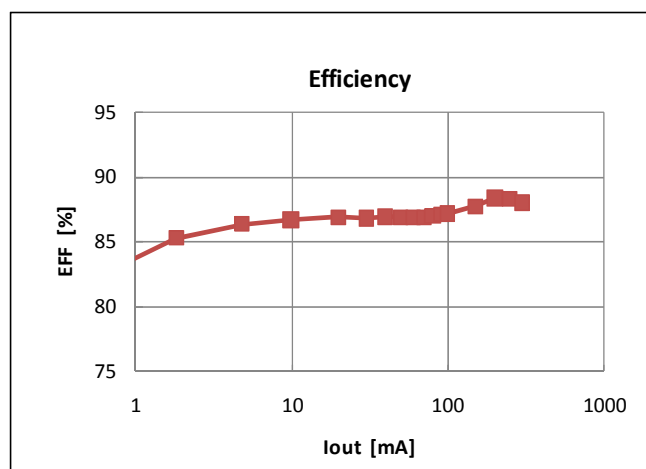
• Vin=3.6V, Vout=2.5V



• $V_{in}=5.0V$, $V_{out}=3.0V$



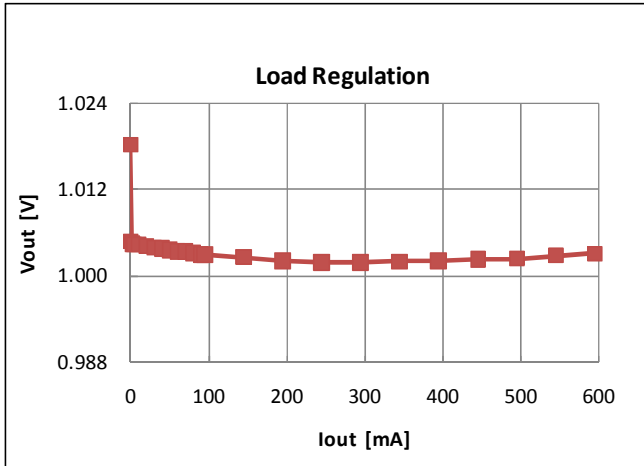
• $V_{in}=5.0V$, $V_{out}=3.3V$



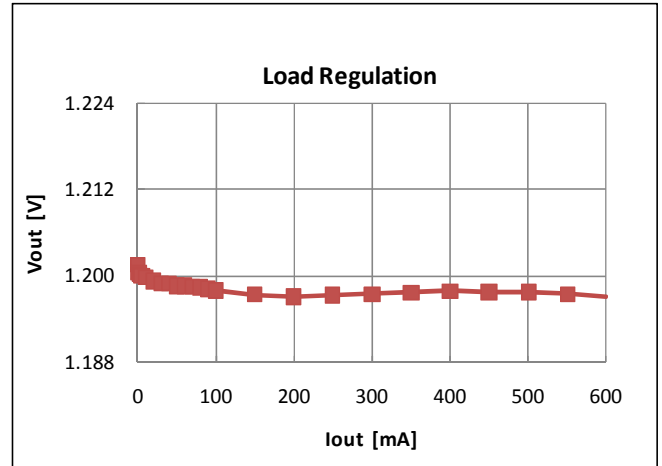
Typical Measurement Data (reference purpose only) (Ta=25°C)

Load Regulation

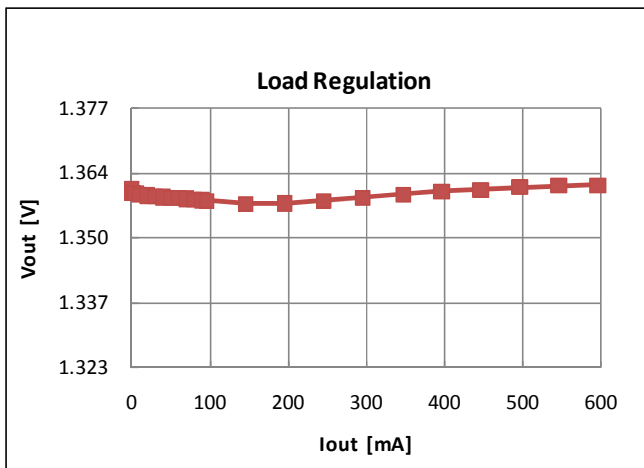
• Vin=3.6V, Vout=1.0V



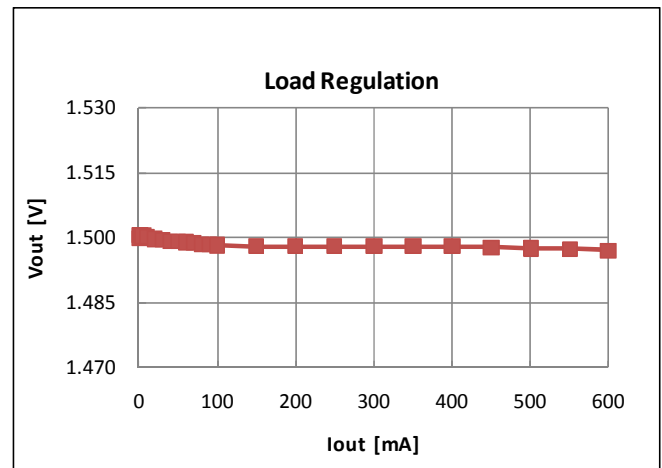
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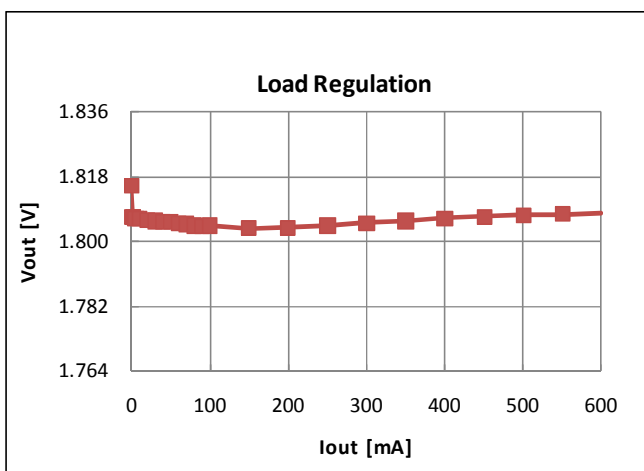
• Vin=3.6V, Vout=1.35V



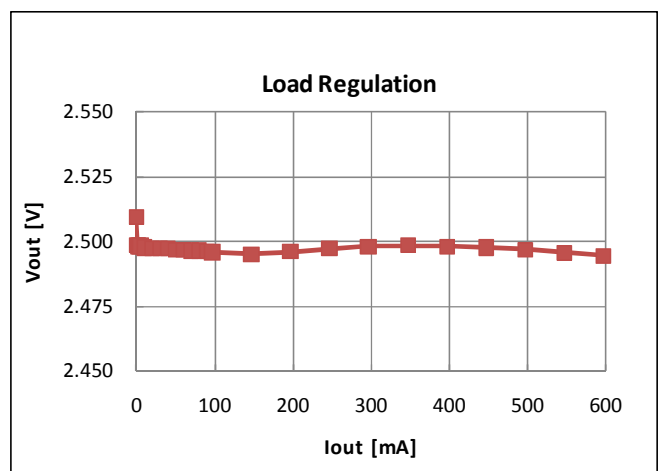
• Vin=3.6V, Vout=1.5V



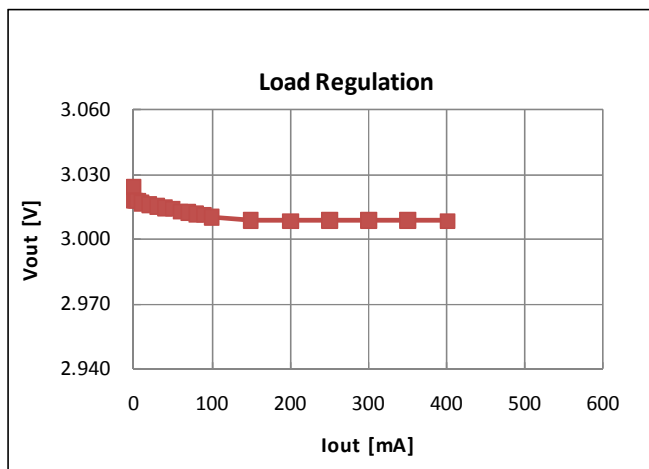
• Vin=3.6V, Vout=1.8V



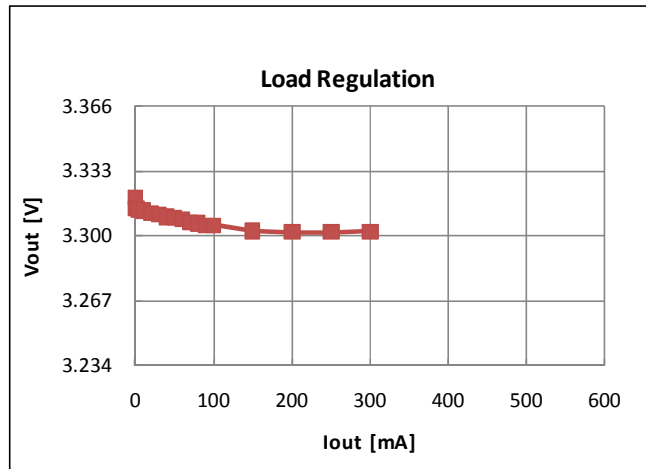
• Vin=3.6V, Vout=2.5V



• $V_{in}=5.0V$, $V_{out}=3.0V$



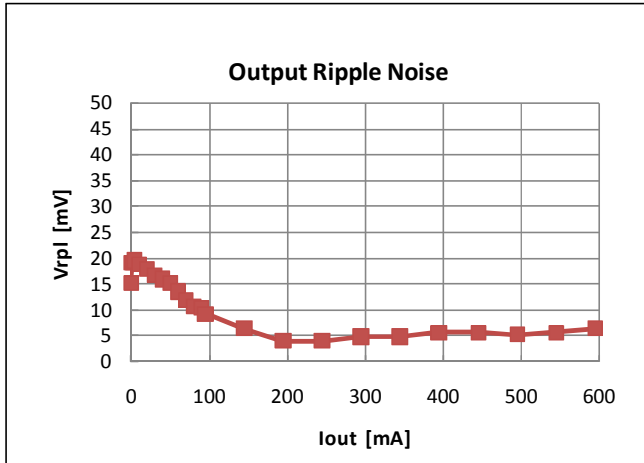
• $V_{in}=5.0V$, $V_{out}=3.3V$



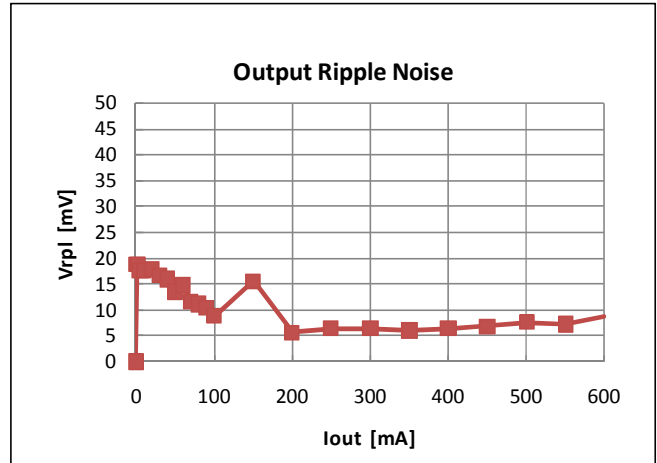
Typical Measurement Data (reference purpose only)

Output Ripple-Noise

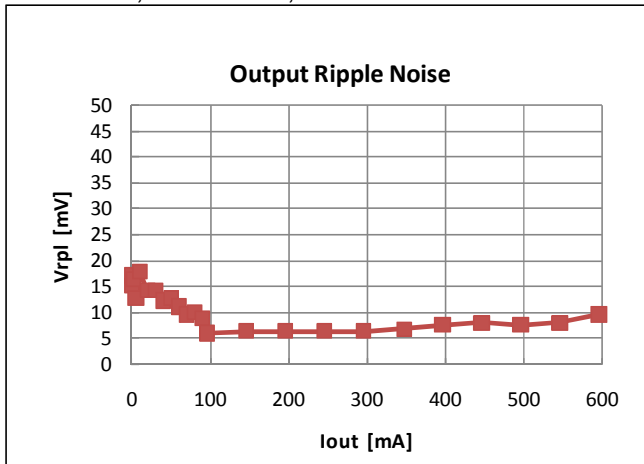
• Vin=3.6V, Vout=1.0V, BW: 150MHz



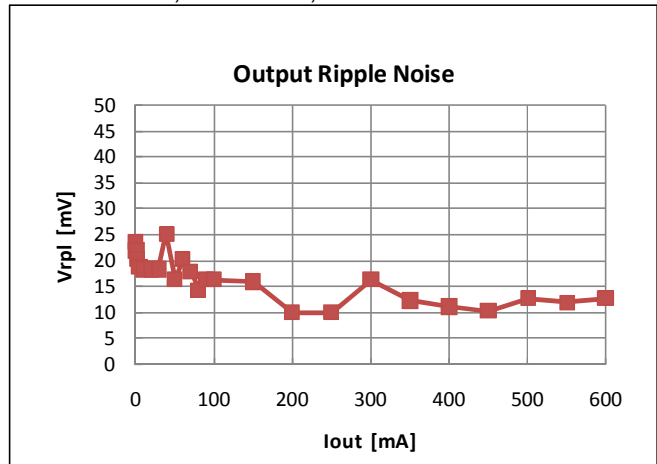
• Vin=3.6V, Vout=1.2V, BW: 150MHz



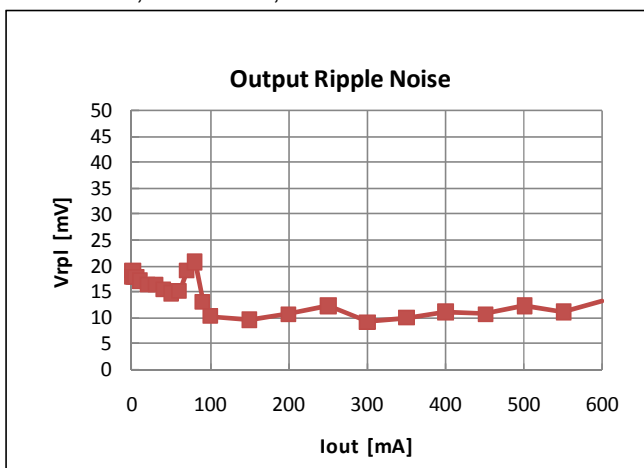
• Vin=3.6V, Vout=1.35V, BW: 150MHz



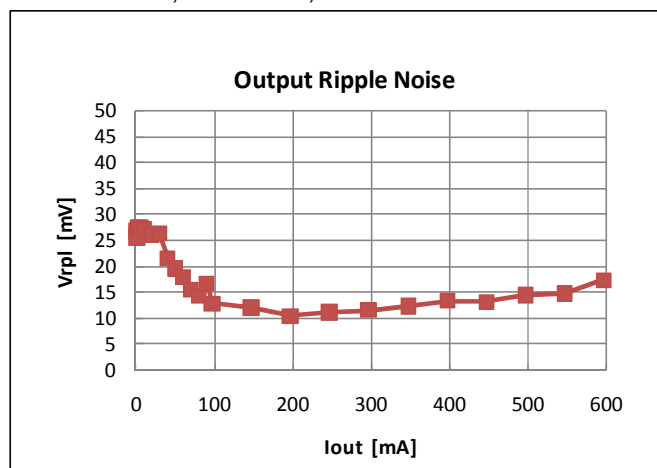
• Vin=3.6V, Vout=1.5V, BW: 150MHz



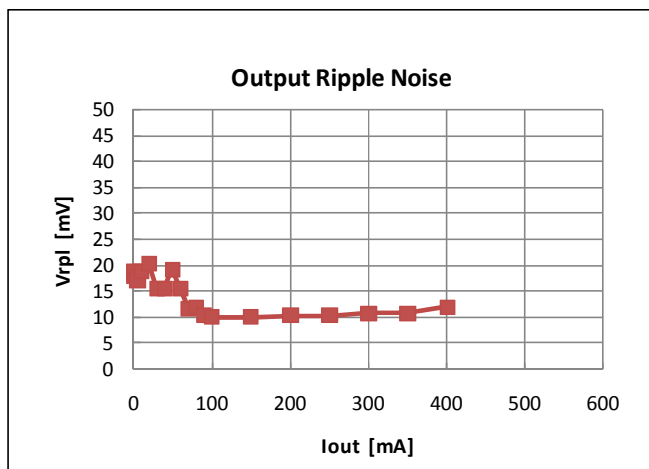
• Vin=3.6V, Vout=1.8V, BW: 150MHz



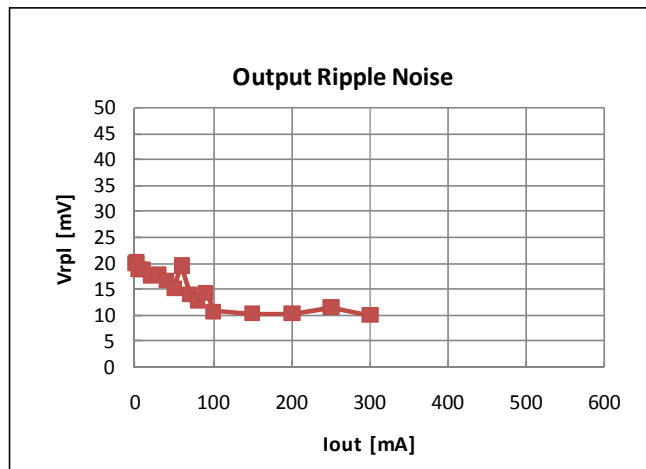
• Vin=3.6V, Vout=2.5V, BW: 150MHz



• $V_{in}=5.0V$, $V_{out}=3.0V$, BW: 150MHz



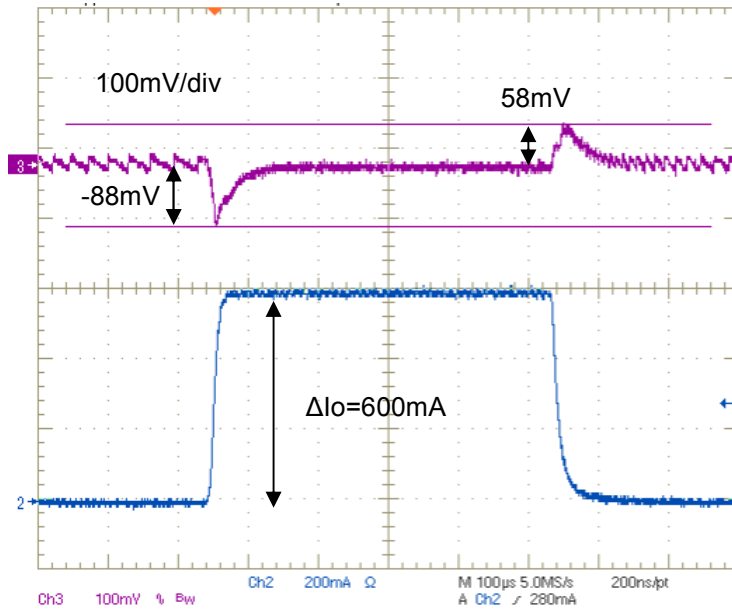
• $V_{in}=5.0V$, $V_{out}=3.3V$, BW: 150MHz



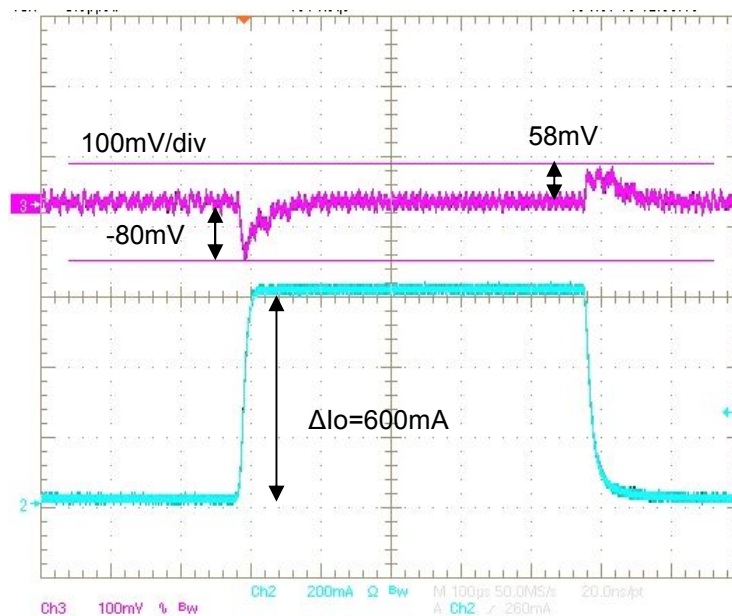
Typical Measurement Data (reference purpose only)

Load Transient Response

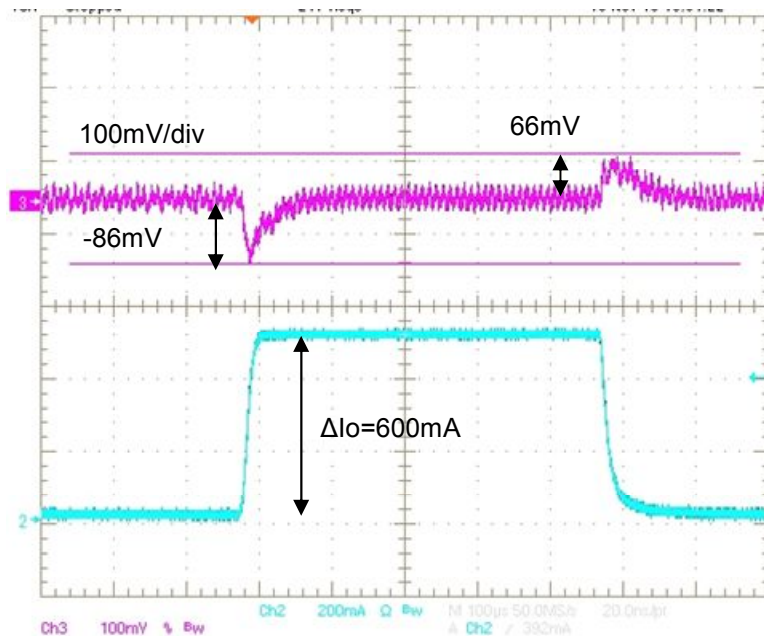
• $V_{in}=3.6V$, $V_{out}=1.0V$



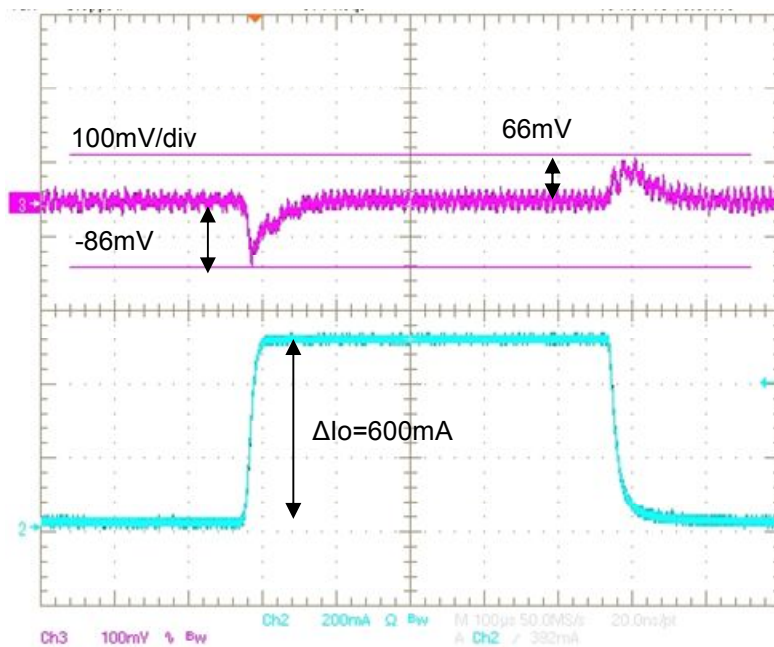
• $V_{in}=3.6V$, $V_{out}=1.2V$



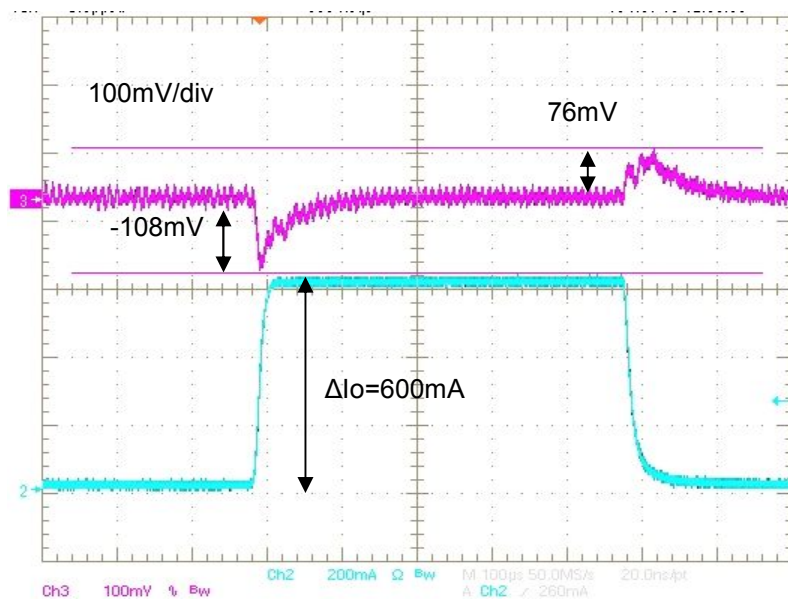
- $V_{in}=3.6V$, $V_{out}=1.35V$



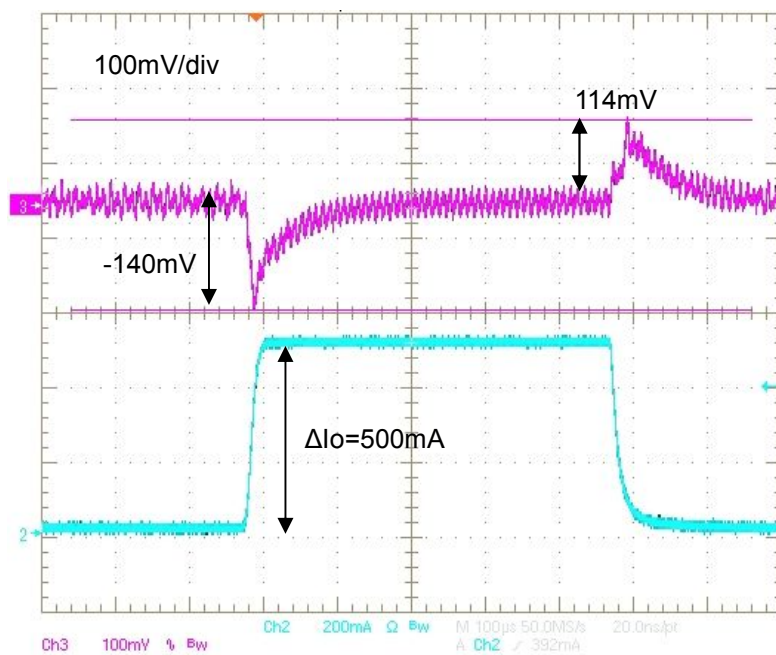
- $V_{in}=3.6V$, $V_{out}=1.5V$



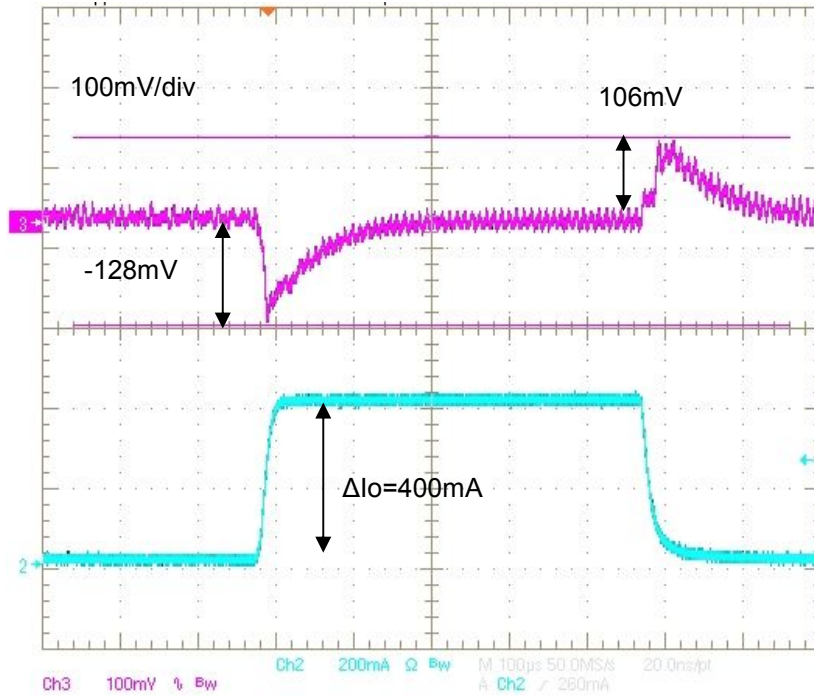
- $V_{in}=3.6V$, $V_{out}=1.8V$



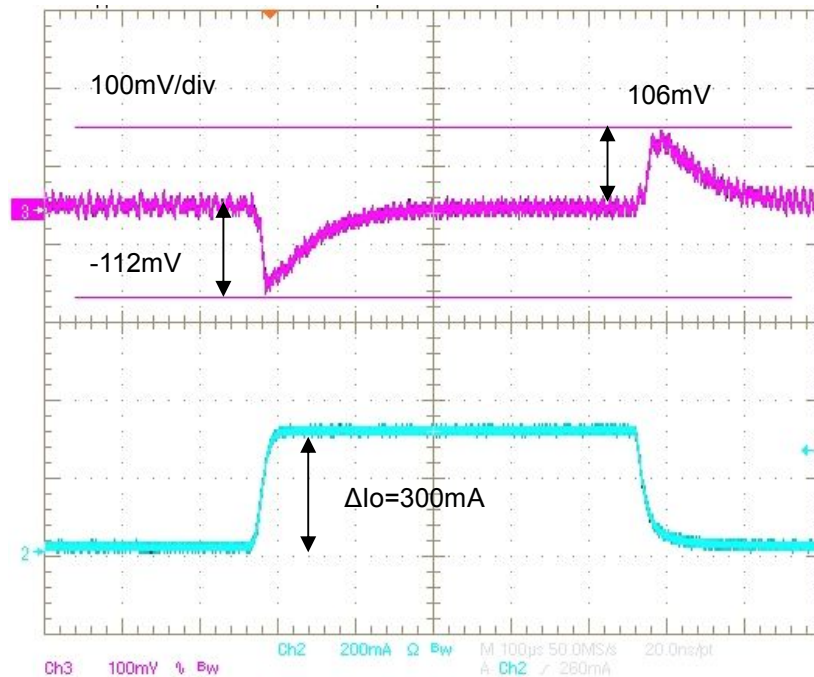
- $V_{in}=3.6V$, $V_{out}=2.5V$



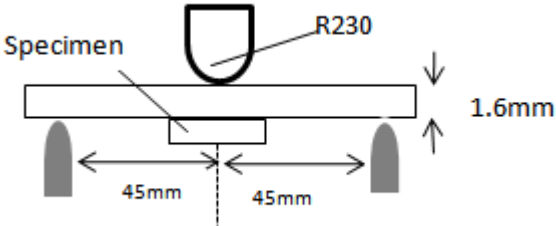
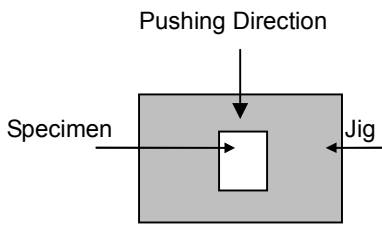
• $V_{in}=5.0V$, $V_{out}=3.0V$



$V_{in}=5.0V$, $V_{out}=3.3V$



8. Reliability Tests

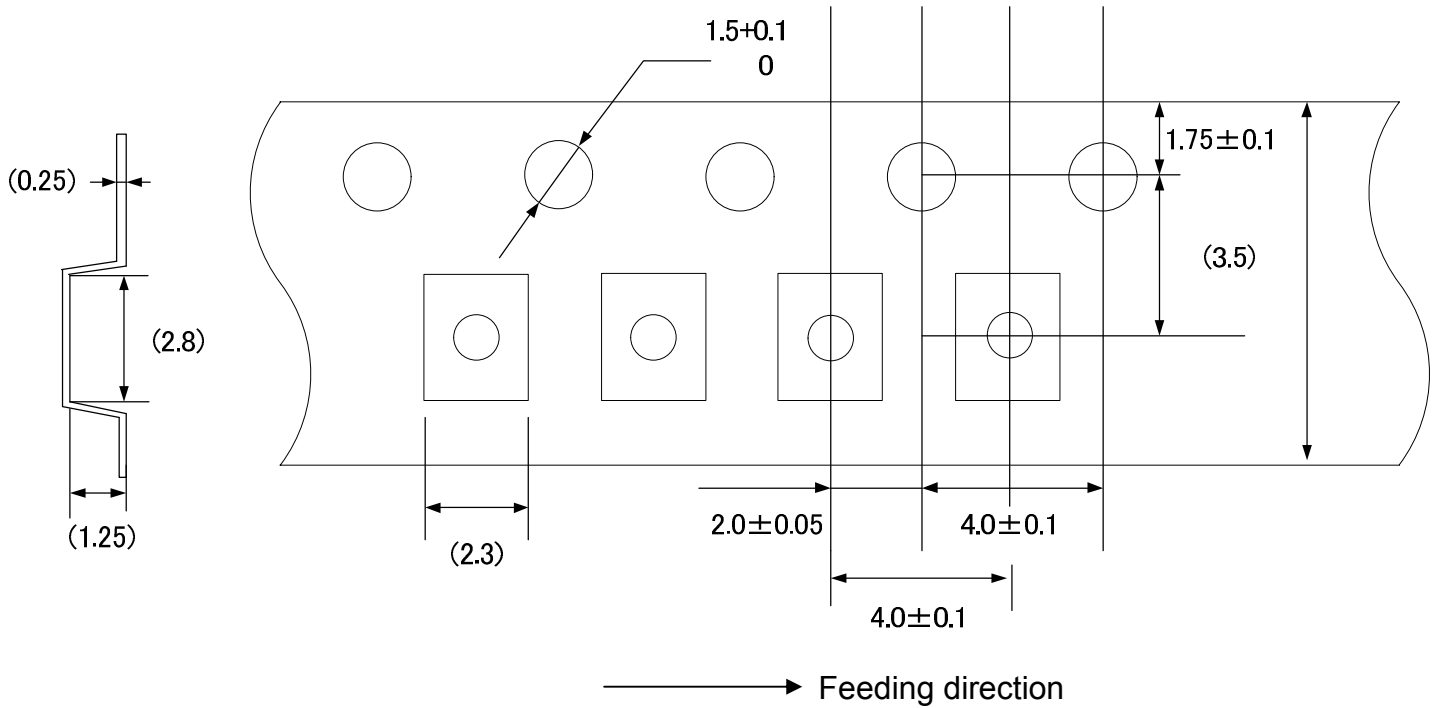
No.	Items	Condition	Number	Result (Fail)
1	Vibration Resistance	Frequency : 10~2000 Hz Acceleration : 196 m/s ² Direction : X,Y,Z 3 axis Period : 2.5h on each	18	G (0)
2	Shock	Acceleration : 980m/s ² Period : 6 ms. Cycle : 6direction x 3 times	18	G (0)
3	Deflection	Solder specimens on the testing jig (glass epoxy boards) shown in appended below figure. No damage with 1.6mm deflection 	18	G (0)
4	Soldering strength (Push Strength)	Solder specimens onto test jig shown below. Apply pushing force at 10N until electrode pads are peeled off or ceramics are broken. Pushing force is applied to longitudinal direction. 	18	G (0)
5	Solderability of Termination	75% of the terminations is to be soldered evenly and continuously.	18	G (0)
6	Heat Shock	Temperature: -40°C 30min , 85°C 30min Period : 30min on each Cycle : 100 times	18	G (0)
7	High Temp Exposure	Temperature: 85°C Period : 1000h	18	G (0)
8	Low Temp Exposure	Temperature: -40°C Period : 1000h	18	G (0)
9	Humidity (Steady State)	Temperature: 85°C Humidity: 85%RH Period : 1000h	18	G (0)

No	Items	Condition	Number	Result (Fail)
10	ESD(Machine Model)	C: 200pF, R: 0 Ω TEST Voltage : +/-200V	18	G (0)
11	ESD(Human Body Model)	C: 100pF, R: 1500 Ω TEST Voltage : +/-2000V	18	G (0)
12	ESD(Charged Machine Model)	Confirming to JEITA4701 300-2 TEST Voltage : +/-500V	18	G (0)

9. Tape and Reel Packing

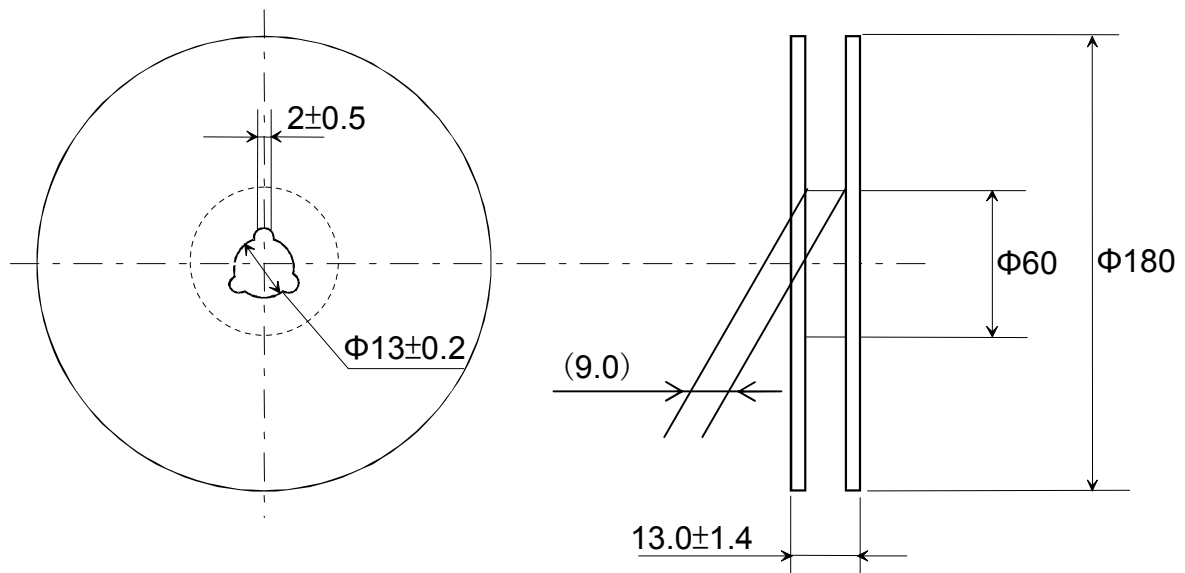
1) Dimensions of Tape (Plastic tape)

Unit: mm



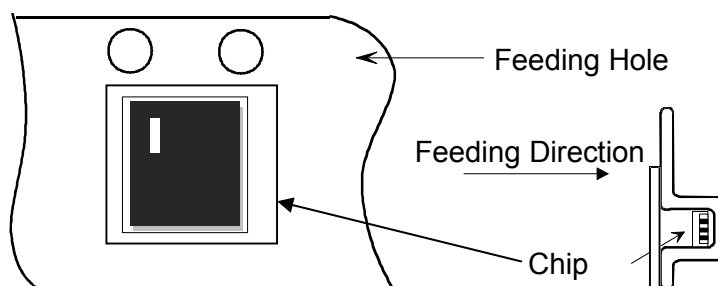
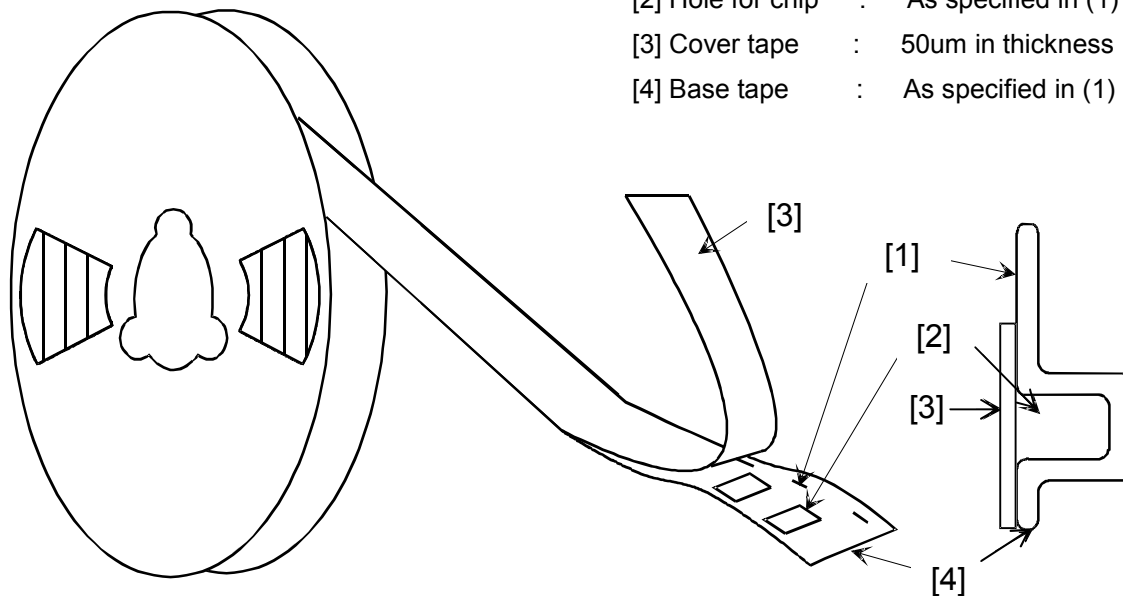
2) Dimensions of Reel

Unit: mm

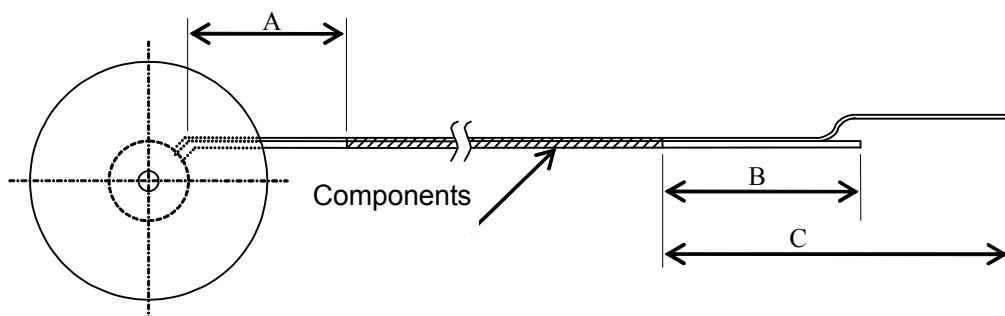


3) Taping Diagrams

- [1] Feeding Hole : As specified in (1)
- [2] Hole for chip : As specified in (1)
- [3] Cover tape : 50um in thickness
- [4] Base tape : As specified in (1)



4) Leader and Tail tape



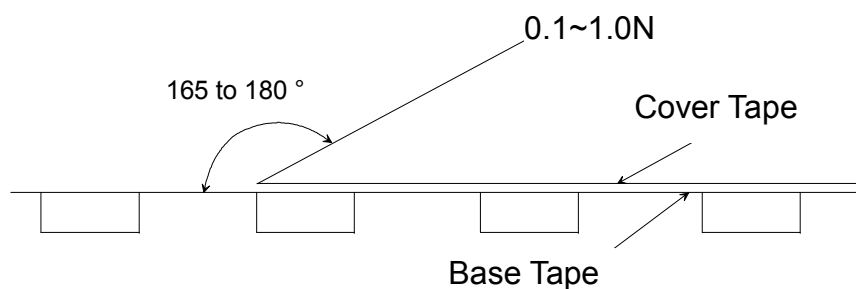
Symbol	Items	Ratings(mm)
A	No components at trailer	min 160
B	No components at leader	min 100
C	Whole leader	min 400

5) The tape for chips are wound clockwise, the feeding holes to the right side as the tape is pulled toward the user.

6) Packaging unit: 3,000 pcs./ reel

7) Material: Base Tape ... Plastic
 Reel ... Plastic
 Antistatic coating for both base tape and reel

8) Peeling of force



NOTICE

1. Storage Conditions:

- The product shall be stored without opening the packing under the ambient temperature from 5 to 35 deg.C and humidity from 20 to 70%RH.
(Packing materials, in particular, may be deformed at the temperature over 40 deg.C.)
- The product left more than 6 months after reception, it needs to be confirmed the solderability before used.
 - The product shall be stored in non corrosive gas (Cl₂, NH₃, SO₂, NO_x, etc.).
 - Any excess mechanical shock including, but not limited to, sticking the packing materials by sharp object and dropping the product, shall not be applied in order not to damage the packing materials.
- After the packing opened, the product shall be stored at ≤ 30 deg.C / ≤ 60 %RH and the product shall be used within 168 hours.

When the color of the indicator in the packing changed, the product shall be baked before soldering.

This product is applicable to MSL3 (Based on IPC/JEDEC J-STD-020)

3. Standard PCB Design (Land Pattern and Dimensions):

All the ground terminals should be connected to ground patterns. Furthermore, the ground pattern should be provided between IN and OUT terminals. Please refer to the specifications for the standard land dimensions.

The recommended land pattern and dimensions are shown for a reference purpose only. Electrical, mechanical and thermal characteristics of the product shall depend on the pattern design and material / thickness of the PCB. Therefore, be sure to check the product performance in the actual set. When using underfill materials, be sure to check the mechanical characteristics in the actual set.

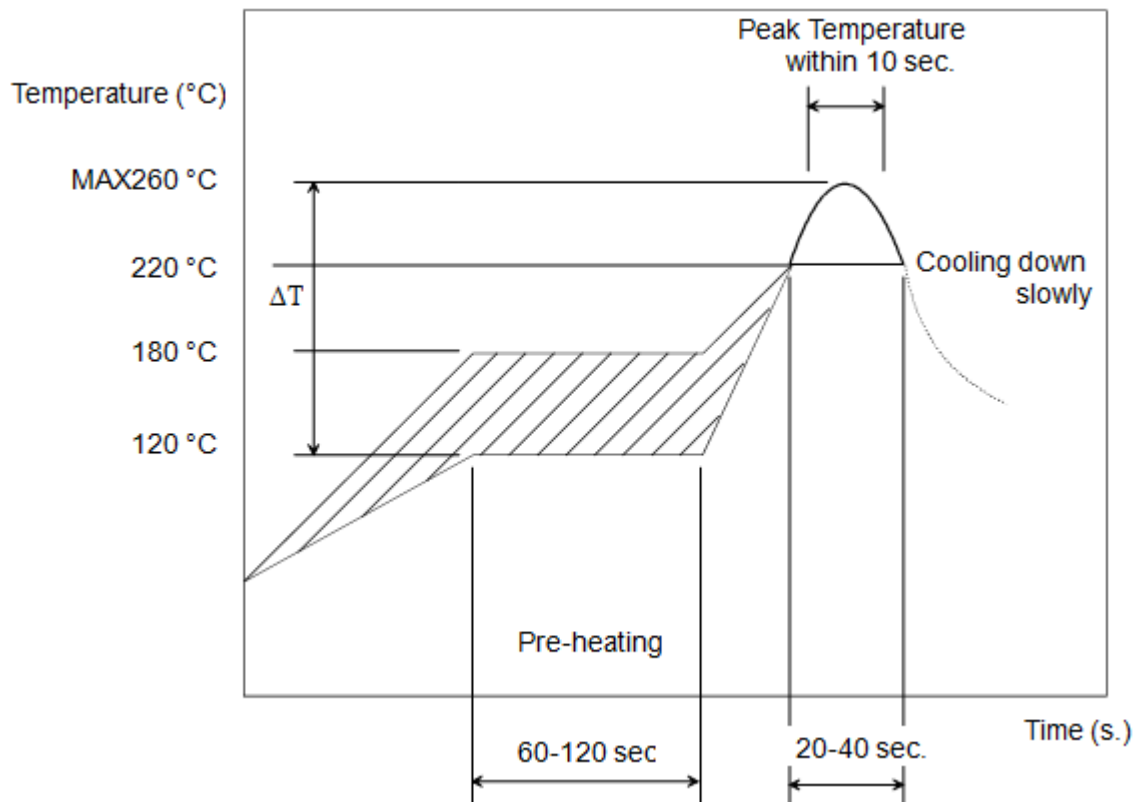
4. Soldering Conditions:

Soldering is allowed up through 2 times.

Carefully perform preheating : ΔT less than 130 °C.

When products are immersed in solvent after mounting, pay special attention to maintain the temperature difference within 100 °C. Soldering must be carried out by the above mentioned conditions to prevent products from damage. Contact Murata before use if concerning other soldering conditions.

Reflow soldering standard conditions (example)



Use rosin type flux or weakly active flux with a chlorine content of 0.2 wt % or less.

5. Cleaning Conditions:

The product is not designed to be cleaned after soldering.

6. Operational Environment Conditions:

Products are designed to work for electronic products under normal environmental conditions (ambient temperature, humidity and pressure). Therefore, products have no problems to be used under the similar conditions to the above-mentioned. However, if products are used under the following circumstances, it may damage products and leakage of electricity and abnormal temperature may occur.

- In an atmosphere containing corrosive gas (Cl_2 , NH_3 , SO_x , NO_x etc.).
- In an atmosphere containing combustible and volatile gases.
- In a dusty environment.
- Direct sunlight
- Water splashing place.
- Humid place where water condenses.
- In a freezing environment.

If there are possibilities for products to be used under the preceding clause, consult with Murata before actual use.

If static electricity is added to this product, degradation and destruction may be produced.

Please use it after consideration enough so that neither static electricity nor excess voltage is added at the time of an assembly and measurement.

If product malfunctions may result in serious damage, including that to human life, sufficient fail-safe measures must be taken, including the following:

- (1) Installation of protection circuits or other protective device to improve system safety
- (2) Installation of redundant circuits in the case of single-circuit failure

7. Input Power Capacity:

Products shall be used in the input power capacity as specified in this specifications.

Inform Murata beforehand, in case that the components are used beyond such input power capacity range.

8. Limitation of Applications:

The products are designed and produced for application in ordinary electronic equipment (AV equipment, OA equipment, telecommunication, etc). If the products are to be used in devices requiring extremely high reliability following the application listed below, you should consult with the Murata staff in advance.

- Aircraft equipment.
- Aerospace equipment
- Undersea equipment.
- Power plant control equipment.
- Medical equipment.
- Transportation equipment (vehicles, trains, ships, etc.).
- Traffic signal equipment.
- Disaster prevention / crime prevention equipment.
- Data-proceession equipment.
- Application which malfunction or operational error may endanger human life and property of assets.
- Application which related to occurrence the serious damage
- Application of similar complexity and/ or reliability requirements to the applications listed in the above.



Note:

Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.

Product specifications are subject to change or our products in it may be discontinued without advance notice.

This catalog is for reference only and not an official product specification document, therefore, please review and approve our official product specification before ordering this product.